

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Takuya Ikeda</td><td>08/22/2011</td></tr><tr><td>Takanori Yamazaki</td><td>07/25/2011</td></tr><tr><td>Hiroshi Tsuchida</td><td>07/25/2011</td></tr></tbody></table>	Name	Execution Date	Takuya Ikeda	08/22/2011	Takanori Yamazaki	07/25/2011	Hiroshi Tsuchida	07/25/2011	
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Takuya Ikeda	08/22/2011								
Takanori Yamazaki	07/25/2011								
Hiroshi Tsuchida	07/25/2011								
RECEIVING PARTY DATA									
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State/Country:	JAPAN								
Postal Code:	103-0023								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13234514</td></tr></tbody></table>	Property Type	Number	Application Number:	13234514					
Property Type	Number								
Application Number:	13234514								
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NAME OF SUBMITTER:	Julie Wang								
Total Attachments: 2 source=223337US-assignment#page1.tif source=223337US-assignment#page2.tif									

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ASSIGNMENT

WHEREAS, we, Takuya IKEDA, Takanori YAMAZAKI, and Hiroshi TSUCHIDA, (hereinafter referred to as ASSIGNORS), having post office addresses of c/o DAIICHI SANKYO COMPANY, LIMITED 1-16-13, Kitakasai, Edogawa-ku, Tokyo 134-8630, Japan, respectively, are the joint inventors of an invention entitled "AMIDE DERIVATIVE" as described and claimed in the specification for which an application for United States letters patent was filed on

9/16/2011 and assigned Application No. 13/234,514.

WHEREAS, DAIICHI SANKYO COMPANY, LIMITED (hereinafter referred to as ASSIGNEE), a corporation of the Country of Japan, having a place of business at 3-5-1, Nihonbashi Honcho, Chuo-ku, Tokyo 103-0023, Japan, is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefor in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE the entire right, title and interest in and to said invention, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNORS had this assignment, transfer and sale not been made. ASSIGNORS hereby authorize and request the Commissioner for Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNORS agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding letters patent, or for the purpose of protecting title to said invention or letters patent therefor.

Applicants' counsel is authorized to insert the official filing date and application number information when it becomes available.

August 22nd 2011  
Date

Takuya Ikeda  
Name: **Takuya IKEDA**

Jul. 25. 2011  
Date

Takanori Yamazaki  
Name: **Takanori YAMAZAKI**

July 25th 2011  
Date

Hiroshi Tsuchida  
Name: **Hiroshi TSUCHIDA**